To all our customers

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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## Silicon Epitaxial Planar Zener Diode for Surge Absorb



ADE-208-468B (Z)

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Rev.2 Nov. 2002

#### Features

- HZM4.3FA has four devices, and can absorb surge.
- MPAK-5 Package is suitable for high density surface mounting and high speed assembly.

| Ordering Informat | ion        |                                   |   |  |
|-------------------|------------|-----------------------------------|---|--|
| Type No.          | Laser Mark |                                   | Package Code  |  |
| HZM4.3FA          | 43A        |                                   | MPAK-5  |  |
| Pin Arrangement   |            | 250                               |   |  |
|                   |            | 1 2<br>4 4<br>5 4 3<br>(Top View) | <ol> <li>Cathode</li> <li>Cathode</li> <li>Cathode</li> <li>Anode</li> <li>Cathode</li> </ol> |  |

#### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

| Item                 | Symbol | Value       | Unit |    |  |
|----------------------|--------|-------------|------|----|--|
| Power dissipation    | Pd *   | 200         | mW   | mW |  |
| Junction temperature | Tj     | 150         | °C   |    |  |
| Storage temperature  | Tstg   | -55 to +150 | °C   |    |  |

Note: Four device total, See Fig.2.

#### **Electrical Characteristics**<sup>\*1</sup>

 $(Ta = 25^{\circ}C)$ 

| Item               | Symbol         | Min  | Тур | Max  | Unit | Test Condition   |
|--------------------|----------------|------|-----|------|------|--|
| Zener voltage      | V <sub>z</sub> | 4.01 | _   | 4.48 | V    | l <sub>z</sub> = 5 mA, 40 ms pulse   |
| Reverse current    | I <sub>R</sub> |      |     | 10   | μA   | V <sub>R</sub> = 1 V   |
| Capacitance        | С              | _    | _   | 150  | pF   | $V_{\rm R} = 0$ V, f = 1 MHz   |
| Dynamic resistance | r <sub>d</sub> | —    | _   | 130  | Ω    | $I_z = 5 \text{ mA}$   |
| ESD-Capability *2  | _              | 30   |     | _    | kV   | C = 150 pF, R = 330 $\Omega$ , Both forward and reverse direction 10 pulse |

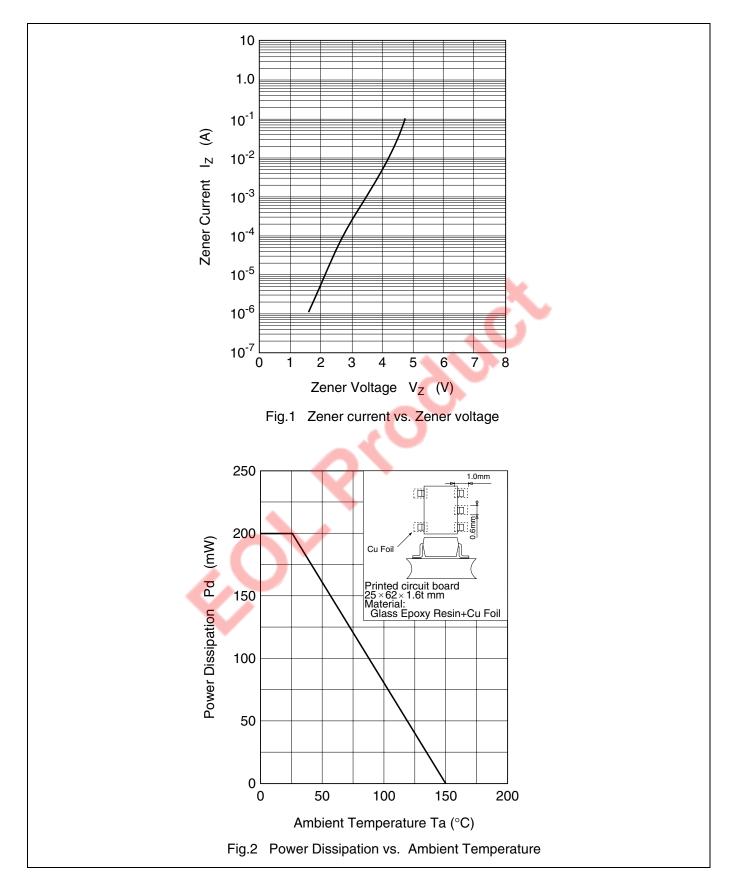
#### Notes: 1. Per one device.

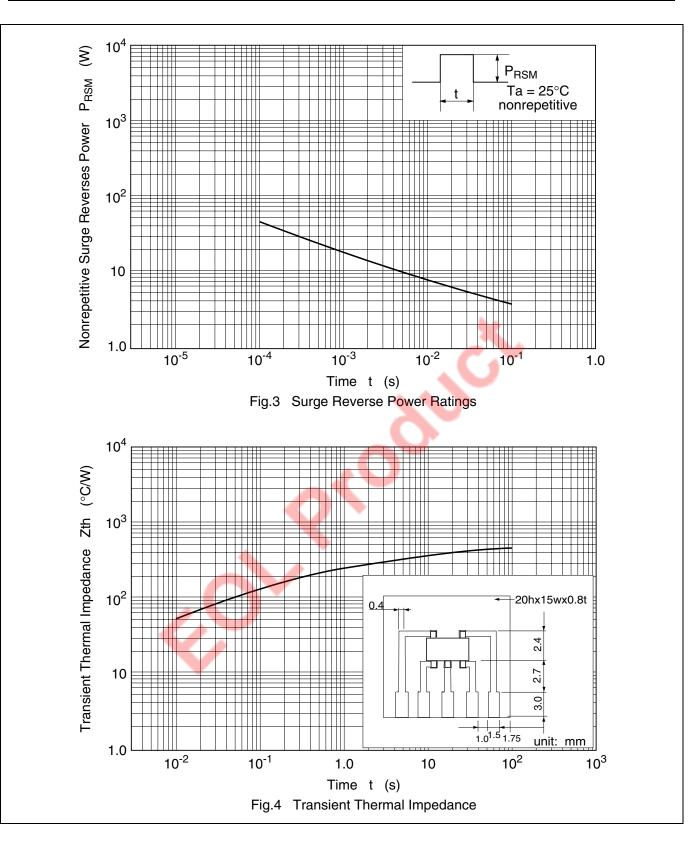
2. Failure criterion ;  $I_{_{\rm R}} > 10 \,\mu\text{A}$  at  $V_{_{\rm R}} = 1 \,\text{V}$ .

60



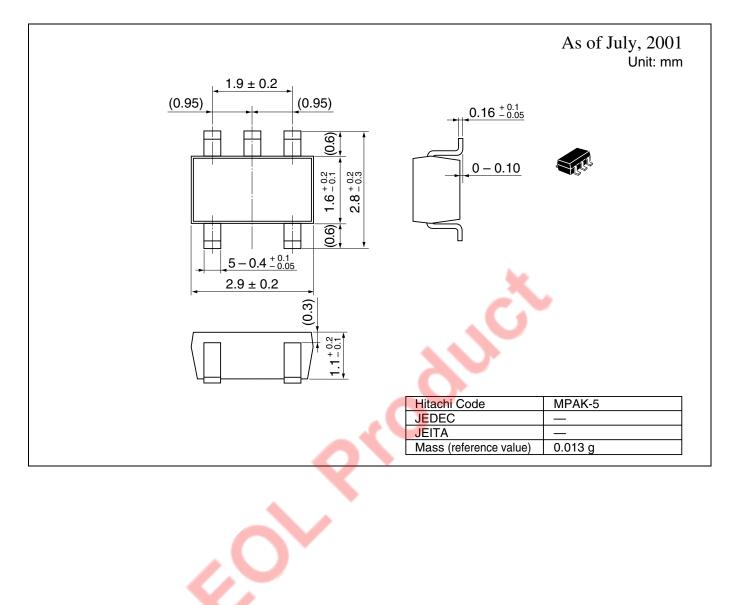
#### **Main Characteristic**





RENESAS

### **Package Dimensions**





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#### Hitachi, Ltd.

Semiconductor & Integrated Circuits Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: (03) 3270-2111 Fax: (03) 3270-5109

Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00

URL http://www.hitachisemiconductor.com/

#### For further information write to:

| (America) Inc.<br>179 East Tasman Drive<br>San Jose,CA 95134<br>Tel: <1> (408) 433-1990 | Hitachi Europe Ltd.<br>Electronic Components Group<br>Whitebrook Park<br>Lower Cookham Road<br>Maidenhead<br>Berkshire SL6 8YA, United Kingdom<br>Tel: <44> (1628) 585000<br>Fax: <44> (1628) 778322 | Hitachi Asia Ltd.<br>Hitachi Tower<br>16 Collyer Quay #20-00<br>Singapore 049318<br>Tel : <65>-6538-6533/6538-8577<br>Fax : <65>-6538-6933/6538-3877<br>URL : http://semiconductor.hitachi.com.sg | Fax : <852>-2730-0281                     |  |
|---|--|---|---|--|
|   | Hitachi Europe GmbH<br>Electronic Components Group<br>Dornacher Str 3<br>D-85622 Feldkirchen<br>Postfach 201, D-85619 Feldkirchen<br>Germany   | Hitachi Asia Ltd.<br>(Taipei Branch Office)<br>4/F, No. 167, Tun Hwa North Road<br>Hung-Kuo Building<br>Taipei (105), Taiwan<br>Tel : <886>-(2)-2718-3666   | URL : http://semiconductor.hitachi.com.hk |  |

Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP

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